SNAS535H - OCTOBER 1999-REVISED MARCH 2013

ADC0808/ADC0809 8-Bit µP Compatible A/D Converters with 8-Channel Multiplexer

Check for Samples: ADC0808-N, ADC0809-N

FEATURES

- Easy Interface to All Microprocessors
- Operates Ratiometrically or with 5 V_{DC} or Analog Span Adjusted Voltage Reference
- No Zero or Full-Scale Adjust Required
- 8-Channel Multiplexer with Address Logic
- 0V to V_{CC} Input Range
- **Outputs meet TTL Voltage Level Specifications**
- ADC0808 Equivalent to MM74C949
- ADC0809 Equivalent to MM74C949-1

KEY SPECIFICATIONS

Resolution: 8 Bits

Total Unadjusted Error: ±1/2 LSB and ±1 LSB

Single Supply: 5 VDC Low Power: 15 mW Conversion Time: 100 µs

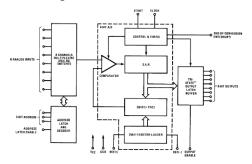
DESCRIPTION

The ADC0808, ADC0809 data acquisition component is a monolithic CMOS device with an 8-bit analog-todigital converter, 8-channel multiplexer microprocessor compatible control logic. The 8-bit A/D converter uses successive approximation as the conversion technique. The converter features a high impedance chopper stabilized comparator, a 256R voltage divider with analog switch tree and a successive approximation register. The 8-channel multiplexer can directly access any of 8-single-ended analog signals.

The device eliminates the need for external zero and interfacing adjustments. Easy microprocessors is provided by the latched and decoded multiplexer address inputs and latched TTL TRI-STATE outputs.

The design of the ADC0808, ADC0809 has been optimized by incorporating the most desirable aspects of several A/D conversion techniques. The ADC0808, ADC0809 offers high speed, high accuracy, minimal excellent temperature dependence, long-term accuracy and repeatability, and consumes minimal power. These features make this device ideally suited to applications from process and machine control to consumer and automotive applications. For 16channel multiplexer with common output (sample/hold port) see ADC0816 data sheet. (See AN-247 (Literature Number SNOA595) for more information.)

Block Diagram



Connection Diagrams

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet All trademarks are the property of their respective owners.



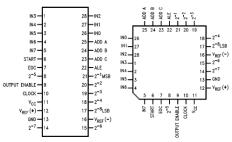


Figure 1. PDIP Package See Package N0028E

Figure 2. PLCC Package See Package FN0028A



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1)(2)(3)

Supply Voltage (V _{CC}) ⁽⁴⁾			6.5V
Supply voltage (VCC)			0.50
Voltage at Any Pin Except Control Inputs			-0.3V to (V _{CC} +0.3V)
Voltage at Control Inputs		-0.3V to +15V	
(START, OE, CLOCK, ALE, ADD A, ADD I			
Storage Temperature Range		-65°C to +150°C	
Package Dissipation at T _A =25°C			875 mW
Lead Temp. (Soldering, 10 seconds)	PDIP Package (plasti	c)	260°C
	PLCC Package	Vapor Phase (60 seconds)	215°C
		Infrared (15 seconds)	220°C
ESD Susceptibility ⁽⁵⁾	·	400V	

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not
- apply when operating the device beyond its specified operating conditions. All voltages are measured with respect to GND, unless otherwise specified.
- If Military/Aerospace specified devices are required, please contact the TI Sales Office/Distributors for availability and specifications. A Zener diode exists, internally, from V_{CC} to GND and has a typical breakdown voltage of 7 V_{DC} . Human body model, 100 pF discharged through a 1.5 k Ω resistor.

Operating Conditions (1)(2)

Sportating Containents	
Temperature Range	T _{MIN} ≤T _A ≤T _{MAX}
	-40°C≤T _A ≤+85°C
Range of V _{CC}	4.5 Vnc to 6.0 Vnc

- Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not (1)
- apply when operating the device beyond its specified operating conditions. All voltages are measured with respect to GND, unless otherwise specified.

Electrical Characteristics – Converter Specifications

Converter Specifications: V_{CC} =5 V_{DC} = V_{REF+} , $V_{REF(-)}$ =GND, T_{MIN} ≤ T_{A} ≤ T_{MAX} and f_{CLK} =640 kHz unless otherwise stated.

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
	ADC0808	25°C			±½	LSB	
	Total Unadjusted Error ⁽¹⁾	TMIN to TMAY			+3/4	LSB	

Total unadjusted error includes offset, full-scale, linearity, and multiplexer errors. See Figure 5. None of these A/Ds requires a zero or full-scale adjust. However, if an all zero code is desired for an analog input other than 0.0V, or if a narrow full-scale span exists (for example: 0.5V to 4.5V full-scale) the reference voltages can be adjusted to achieve this. See Figure 15.

Submit Documentation Feedback

Copyright © 1999-2013, Texas Instruments Incorporated

Product Folder Links: ADC0808-N ADC0809-N

NSTRUMENTS

Texas

Electrical Characteristics - Converter Specifications (continued)

Converter Specifications: V_{CC}=5 V_{DC}=V_{REF+}, V_{REF(-)}=GND, T_{MIN}≤T_A≤T_{MAX} and f_{CLK}=640 kHz unless otherwise stated.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
	ADC0809	0°C to 70°C			±1	LSB
	Total Unadjusted Error ⁽¹⁾	T _{MIN} to T _{MAX}			±11/4	LSB
	Input Resistance	From Ref(+) to Ref(-)	1.0	2.5		kΩ
	Analog Input Voltage Range	See (2) V(+) or V(-)	GND - 0.1		V _{CC} + 0.1	V _{DC}
V _{REF(+)}	Voltage, Top of Ladder	Measured at Ref(+)		Vcc	V _{CC} + 0.1	V
$\frac{V_{REF(+)}+V_{REF(-)}}{2}$	Voltage, Center of Ladder		(V _{CC} /2) - 0.1	V _{CC} /2	(V _{CC} /2) + 0.1	٧
V _{REF(-)}	Voltage, Bottom of Ladder	Measured at Ref(-)	-0.1	0		V
I _{IN}	Comparator Input Current	f _c =640 kHz, (3)	-2	±0.5	2	μA

Two on-chip diodes are tied to each analog input which will forward conduct for analog input voltages one diode drop below ground or one diode drop greater than the V_{CC} n supply. The spec allows 100 mV forward bias of either diode. This means that as long as the analog V_{H} , does not exceed the supply voltage by more than 100 mV, the output code will be correct. To achieve an absolute $0V_{DC}$ to $5V_{DC}$ input voltage range will therefore require a minimum supply voltage of 4.900 V_{DC} over temperature variations, initial tolerance and

Electrical Characteristics - Digital Levels and DC Specifications

Digital Levels and DC Specifications: ADC0808CCN, ADC0808CCV, ADC0809CCN and ADC0809CCV, 4.75≤V_{CC}≤5.25V, -40°C≤T_A≤+85°C unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
ANALOG MUL	TIPLEXER					
		V _{CC} =5V, V _{IN} =5V,				
I _{OFF(+)}	OFF Channel Leakage Current	T _A =25°C		10	200	nA
		T _{MIN} to T _{MAX}			1.0	μΑ
		V _{CC} =5V, V _{IN} =0,				
I _{OFF(-)}	OFF Channel Leakage Current	T _A =25°C	-200	-10		nA
		T _{MIN} to T _{MAX}	-1.0			μΑ
CONTROL INF	PUTS					
V _{IN(1)}	Logical "1" Input Voltage		(V _{CC} - 1.5)			V
V _{IN(0)}	Logical "0" Input Voltage				1.5	V
I _{IN(1)}	Logical "1" Input Current (The Control Inputs)	V _{IN} =15V			1.0	μΑ
I _{IN(0)}	Logical "0" Input Current (The Control Inputs)	V _{IN} =0	-1.0			μА
Icc	Supply Current	f _{CLK} =640 kHz		0.3	3.0	mA
DATA OUTPU	TS AND EOC (INTERRUPT)		·			
V _{OUT(1)}	Logical "1" Output Voltage	V _{CC} = 4.75V I _{OUT} = -360μA I _{OUT} = -10μA	2.4 4.5			V V
V _{OUT(0)}	Logical "0" Output Voltage	I _O =1.6 mA			0.45	V
V _{OUT(0)}	Logical "0" Output Voltage EOC	I _O =1.2 mA			0.45	V
	TRI-STATE Output Current	V ₀ =5V			3	μA
I _{OUT}	TRI-STATE Output Current	V _O =0	-3			μA

Electrical Characteristics – Timing Specifications

Timing Specifications $V_{CC}=V_{REF(+)}=5V$, $V_{REF(-)}=GND$, $t_r=t_r=20$ ns and $T_A=25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	MIn	Тур	Max	Units
tstclk	Start Time Delay from Clock	(Figure 7)	300		900	ns

Copyright © 1999-2013, Texas Instruments Incorporated

Submit Documentation Feedback

Comparator input current is a bias current into or out of the chopper stabilized comparator. The bias current varies directly with clock frequency and has little temperature dependence (Figure 8). See ANALOG COMPARATOR INPUTS



Electrical Characteristics - Timing Specifications (continued)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{WS}	Minimum Start Pulse Width	(Figure 7)		100	200	ns
t _{WALE}	Minimum ALE Pulse Width	(Figure 7)		100	200	ns
t _s	Minimum Address Set-Up Time	(Figure 7)		25	50	ns
t _H	Minimum Address Hold Time	(Figure 7)		25	50	ns
t _D	Analog MUX Delay Time From ALE	R _S =0Ω (Figure 7)		1	2.5	μs
t _{H1} , t _{H0}	OE Control to Q Logic State	C _L =50 pF, R _L =10k (Figure 10)		125	250	ns
t _{1H} , t _{0H}	OE Control to Hi-Z	C _L =10 pF, R _L =10k (Figure 10)		125	250	ns
tc	Conversion Time	f _c =640 kHz, (Figure 7) ⁽¹⁾	90	100	116	μs
f _c	Clock Frequency		10	640	1280	kHz
t _{EOC}	EOC Delay Time	(Figure 7)	0		8 + 2 µS	Clock Periods
C _{IN}	Input Capacitance	At Control Inputs		10	15	pF
C _{OUT}	TRI-STATE Output Capacitance	At TRI-STATE Outputs		10	15	pF

⁽¹⁾ The outputs of the data register are updated one clock cycle before the rising edge of EOC.



Functional Description

MULTIPLEXER

The device contains an 8-channel single-ended analog signal multiplexer. A particular input channel is selected by using the address decoder. Table 1 shows the input states for the address lines to select any channel. The address is latched into the decoder on the low-to-high transition of the address latch enable signal.

Table 1. Analog Channel Selection

SELECTED ANALOG	ADDRESS LINE					
CHANNEL	С	В	Α			
IN0	L	L	L			
IN1	L	L	Н			
IN2	L	Н	L			
IN3	L	Н	Н			
IN4	Н	L	L			
IN5	Н	L	Н			
IN6	Н	Н	L			
IN7	Н	Н	Н			

CONVERTER CHARACTERISTICS

The Converter

The heart of this single chip data acquisition system is its 8-bit analog-to-digital converter. The converter is designed to give fast, accurate, and repeatable conversions over a wide range of temperatures. The converter is partitioned into 3 major sections: the 256R ladder network, the successive approximation register, and the comparator. The converter's digital outputs are positive true.

The 256R ladder network approach (Figure 3) was chosen over the conventional R/2R ladder because of its inherent monotonicity, which ensures no missing digital codes. Monotonicity is particularly important in closed loop feedback control systems. A non-monotonic relationship can cause oscillations that will be catastrophic for the system. Additionally, the 256R network does not cause load variations on the reference voltage.

The bottom resistor and the top resistor of the ladder network in Figure 3 are not the same value as the remainder of the network. The difference in these resistors causes the output characteristic to be symmetrical with the zero and full-scale points of the transfer curve. The first output transition occurs when the analog signal has reached +½ LSB and succeeding output transitions occur every 1 LSB later up to full-scale.

The successive approximation register (SAR) performs 8 iterations to approximate the input voltage. For any SAR type converter, n-iterations are required for an n-bit converter. Figure 4 shows a typical example of a 3-bit converter. In the ADC0808, ADC0809, the approximation technique is extended to 8 bits using the 256R network.

The A/D converter's successive approximation register (SAR) is reset on the positive edge of the start conversion start pulse. The conversion is begun on the falling edge of the start conversion pulse. A conversion in process will be interrupted by receipt of a new start conversion pulse. Continuous conversion may be accomplished by tying the end-of-conversion (EOC) output to the SC input. If used in this mode, an external start conversion pulse should be applied after power up. End-of-conversion will go low between 0 and 8 clock pulses after the rising edge of start conversion.

The most important section of the A/D converter is the comparator. It is this section which is responsible for the ultimate accuracy of the entire converter. It is also the comparator drift which has the greatest influence on the repeatability of the device. A chopper-stabilized comparator provides the most effective method of satisfying all the converter requirements.

The chopper-stabilized comparator converts the DC input signal into an AC signal. This signal is then fed through a high gain AC amplifier and has the DC level restored. This technique limits the drift component of the amplifier since the drift is a DC component which is not passed by the AC amplifier. This makes the entire A/D converter extremely insensitive to temperature, long term drift and input offset errors.

Copyright © 1999–2013, Texas Instruments Incorporated

Submit Documentation Feedback



Figure 6 shows a typical error curve for the ADC0808.

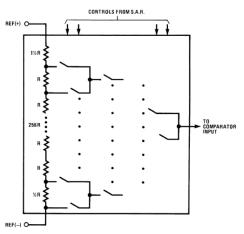


Figure 3. Resistor Ladder and Switch Tree



Figure 4. 3-Bit A/D Transfer Curve

Figure 5. 3-Bit A/D Absolute Accuracy Curve



Figure 6. Typical Error Curve

Submit Documentation Feedback

Copyright © 1999–2013, Texas Instruments Incorporated

Timing Diagram

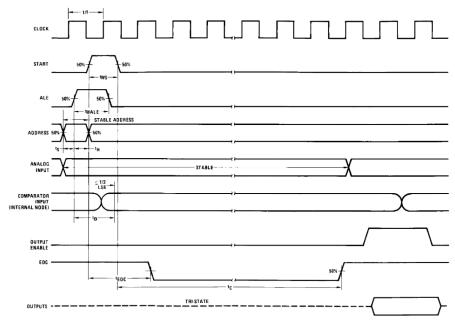
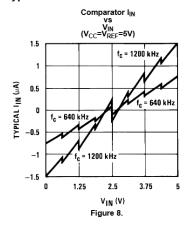
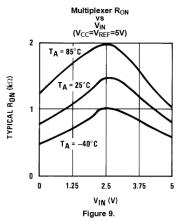


Figure 7.



Typical Performance Characteristics







TRI-STATE Test Circuits and Timing Diagrams

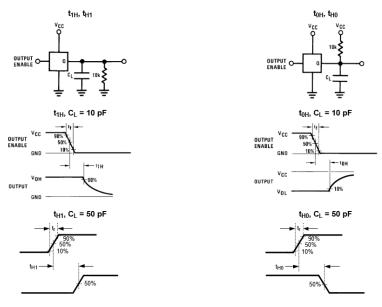


Figure 10. TRI-STATE Test Circuits and Timing Diagrams



APPLICATIONS INFORMATION

OPERATION

RATIOMETRIC CONVERSION

The ADC0808, ADC0809 is designed as a complete Data Acquisition System (DAS) for ratiometric conversion systems. In ratiometric systems, the physical variable being measured is expressed as a percentage of full-scale which is not necessarily related to an absolute standard. The voltage input to the ADC0808 is expressed by the equation

$$\frac{v_{IN}}{v_{fs} - v_Z} = \frac{D_X}{D_{MAX} - D_{MIN}}$$

- V_{IN}= Input voltage into the ADC0808
- V_{fs}= Full-scale voltage
- V_Z= Zero voltage
- D_X= Data point being measured
- D_{MAX}= Maximum data limit
- D_{MIN}= Minimum data limit

A good example of a ratiometric transducer is a potentiometer used as a position sensor. The position of the wiper is directly proportional to the output voltage which is a ratio of the full-scale voltage across it. Since the data is represented as a proportion of full-scale, reference requirements are greatly reduced, eliminating a large source of error and cost for many applications. A major advantage of the ADC0808, ADC0809 is that the input voltage range is equal to the supply range so the transducers can be connected directly across the supply and their outputs connected directly into the multiplexer inputs, (Figure 11).

Ratiometric transducers such as potentiometers, strain gauges, thermistor bridges, pressure transducers, etc., are suitable for measuring proportional relationships; however, many types of measurements must be referred to an absolute standard such as voltage or current. This means a system reference must be used which relates the full-scale voltage to the standard volt. For example, if $V_{CC} = V_{REF} = 5.12V$, then the full-scale range is divided into 256 standard steps. The smallest standard step is 1 LSB which is then 20 mV.

RESISTOR LADDER LIMITATIONS

The voltages from the resistor ladder are compared to the selected into 8 times in a conversion. These voltages are coupled to the comparator via an analog switch tree which is referenced to the supply. The voltages at the top, center and bottom of the ladder must be controlled to maintain proper operation.

The top of the ladder, Ref(+), should not be more positive than the supply, and the bottom of the ladder, Ref(-), should not be more negative than ground. The center of the ladder voltage must also be near the center of the supply because the analog switch tree changes from N-channel switches to P-channel switches. These limitations are automatically satisfied in ratiometric systems and can be easily met in ground referenced systems.

Figure 12 shows a ground referenced system with a separate supply and reference. In this system, the supply must be trimmed to match the reference voltage. For instance, if a 5.12V is used, the supply should be adjusted to the same voltage within 0.1V.

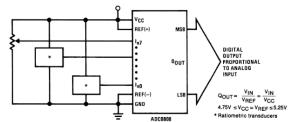


Figure 11. Ratiometric Conversion System

Submit Documentation Feedback

Copyright © 1999-2013, Texas Instruments Incorporated



The ADC0808 needs less than a milliamp of supply current so developing the supply from the reference is readily accomplished. In Figure 13 a ground referenced system is shown which generates the supply from the reference. The buffer shown can be an op amp of sufficient drive to supply the milliamp of supply current and the desired bus drive, or if a capacitive bus is driven by the outputs a large capacitor will supply the transient supply current as seen in Figure 14. The LM301 is overcompensated to insure stability when loaded by the 10 μ F output capacitor.

The top and bottom ladder voltages cannot exceed $V_{\rm CC}$ and ground, respectively, but they can be symmetrically less than $V_{\rm CC}$ and greater than ground. The center of the ladder voltage should always be near the center of the supply. The sensitivity of the converter can be increased, (i.e., size of the LSB steps decreased) by using a symmetrical reference system. In Figure 15, a 2.5V reference is symmetrically centered about $V_{\rm CC}/2$ since the same current flows in identical resistors. This system with a 2.5V reference allows the LSB bit to be half the size of a 5V reference system.

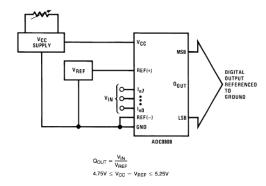


Figure 12. Ground Referenced Conversion System Using Trimmed Supply

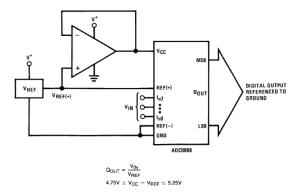


Figure 13. Ground Referenced Conversion System with Reference Generating V_{CC} Supply

Copyright © 1999–2013, Texas Instruments Incorporated

Submit Documentation Feedback



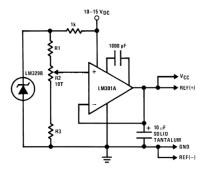
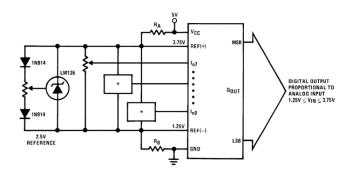


Figure 14. Typical Reference and Supply Circuit



R_A=R_B

*Ratiometric transducers

Figure 15. Symmetrically Centered Reference

CONVERTER EQUATIONS

The transition between adjacent codes N and N+1 is given by:

$$V_{IN} = \left\{ (V_{REF(+)} - V_{REF(-)}) \left[\frac{N}{256} + \frac{1}{512} \right] \pm V_{TUE} \right\} + V_{REF(-)}$$
(2)

The center of an output code N is given by:

$$V_{IN}\left\{ (V_{REF(+)} - V_{REF(-)}) \left[\frac{N}{256} \right] \pm V_{TUE} \right\} + V_{REF(-)}$$
(3)

The output code N for an arbitrary input are the integers within the range:

$$N = \frac{V_{IN} - V_{REF(-)}}{V_{REF(+)} - V_{REF(-)}} \times 256 \pm Absolute Accuracy$$

Where:

- $\bullet \quad V_{IN} \text{=} Voltage \ at \ comparator \ input$
- V_{REF(+)}=Voltage at Ref(+)
- V_{REF(-)}=Voltage at Ref(-)
- V_{TUE}=Total unadjusted error voltage (typically
- V_{REF(+)}÷512)

(4)

12 Submit Documentation Feedback

Copyright © 1999–2013, Texas Instruments Incorporated
Product Folder Links: ADC0808-N ADC0809-N



ANALOG COMPARATOR INPUTS

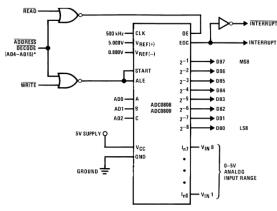
The dynamic comparator input current is caused by the periodic switching of on-chip stray capacitances. These are connected alternately to the output of the resistor ladder/switch tree network and to the comparator input as part of the operation of the chopper stabilized comparator.

The average value of the comparator input current varies directly with clock frequency and with V_{IN} as shown in Figure 8.

If no filter capacitors are used at the analog inputs and the signal source impedances are low, the comparator input current should not introduce converter errors, as the transient created by the capacitance discharge will die out before the comparator output is strobed.

If input filter capacitors are desired for noise reduction and signal conditioning they will tend to average out the dynamic comparator input current. It will then take on the characteristics of a DC bias current whose effect can be predicted conventionally.

Typical Application



^{*}Address latches needed for 8085 and SC/MP interfacing the ADC0808 to a microprocessor

Table 2. Microprocessor Interface Table

PROCESSOR	READ	WRITE	INTERRUPT (COMMENT)
8080	MEMR	MEMW	INTR (Thru RST Circuit)
8085	RD	WR	INTR (Thru RST Circuit)
Z-80	RD	WR	INT (Thru RST Circuit, Mode 0)
SC/MP	NRDS	NWDS	SA (Thru Sense A)
6800	VMA•φ2•R/W	VMA•φ•R/W	IRQA or IRQB (Thru PIA)



13

SNAS535H - OCTOBER 1999-REVISED MARCH 2013 www.ti.com

REVISION HISTORY

Cl	nanges from Revision G (March 2013) to Revision H	Page
	Changed layout of National Data Sheet to TI format	13

Product Folder Links: ADC0808-N ADC0809-N





15-Apr-2017

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
ADC0808CCN	NRND	PDIP	N	28	13	TBD	Call TI	Call TI	-40 to 85	ADC0808CCN	
ADC0808CCN/NOPB	ACTIVE	PDIP	N	28	13	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 85	ADC0808CCN	Samples
ADC0808CCV	NRND	PLCC	FN	28	35	TBD	Call TI	Call TI	-40 to 85	ADC0808 CCV	
ADC0808CCV/NOPB	ACTIVE	PLCC	FN	28	35	Green (RoHS & no Sb/Br)	CU SN	Level-2A-245C-4 WEEK	-40 to 85	ADC0808 CCV	Samples
ADC0808CCVX	NRND	PLCC	FN	28	750	TBD	Call TI	Call TI	-40 to 85	ADC0808 CCV	
ADC0808CCVX/NOPB	ACTIVE	PLCC	FN	28	750	Green (RoHS & no Sb/Br)	CU SN	Level-2A-245C-4 WEEK	-40 to 85	ADC0808 CCV	Samples
ADC0809CCN	NRND	PDIP	N	28	13	TBD	Call TI	Call TI	-40 to 85	ADC0809CCN	
ADC0809CCN/NOPB	ACTIVE	PDIP	N	28	13	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 85	ADC0809CCN	Samples
ADC0809CCV	NRND	PLCC	FN	28	35	TBD	Call TI	Call TI	-40 to 85	ADC0809 CCV	
ADC0809CCV/NOPB	ACTIVE	PLCC	FN	28	35	Green (RoHS & no Sb/Br)	CU SN	Level-2A-245C-4 WEEK	-40 to 85	ADC0809 CCV	Samples
ADC0809CCVX	NRND	PLCC	FN	28	750	TBD	Call TI	Call TI	-40 to 85	ADC0809 CCV	
ADC0809CCVX/NOPB	ACTIVE	PLCC	FN	28	750	Green (RoHS & no Sb/Br)	CU SN	Level-2A-245C-4 WEEK	-40 to 85	ADC0809 CCV	Samples
MM74C949N	NRND	PDIP	N	28	13	TBD	Call TI	Call TI	-40 to 85	ADC0808CCN	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

PACKAGE OPTION ADDENDUM



ww.ti.com 15-Apr-2017

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, Tl Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

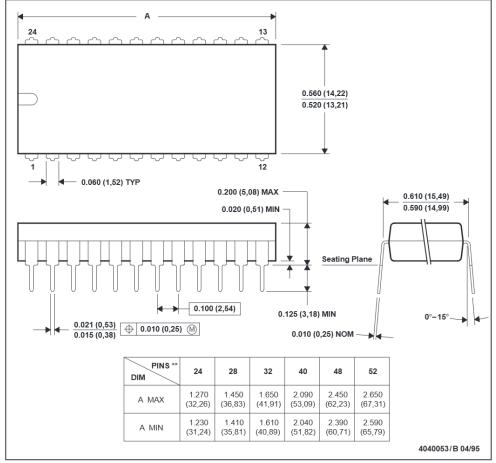
Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

N (R-PDIP-T**)

24 PIN SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



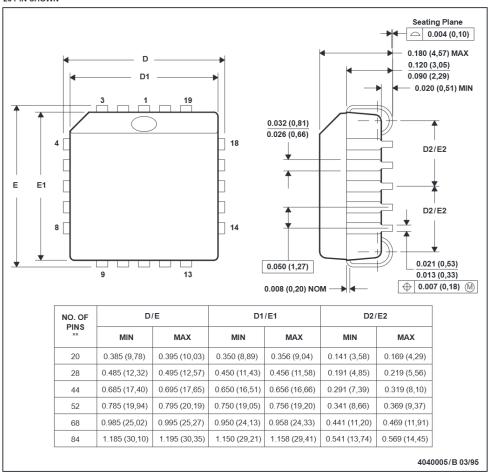
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-011
 D. Falls within JEDEC MS-015 (32 pin only)



FN (S-PQCC-J**)

20 PIN SHOWN

PLASTIC J-LEADED CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.C. Falls within JEDEC MS-018



IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (http://www.ti.com/sc/docs/stdterms.htm) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

Ti's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's noncompliance with the terms and provisions of this Notice.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2017, Texas Instruments Incorporated